PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Tao Hong	07/05/2011
Markus Thoben	07/09/2011

RECEIVING PARTY DATA

Name:	Infineon Technologies AG	
Street Address:	Am Campeon 1-12	
City:	Neubiberg	
State/Country:	GERMANY	
Postal Code:	85579	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13163200

CORRESPONDENCE DATA

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NAME OF SUBMITTER: Mark R. Bilak

Total Attachments: 1

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PATENT REEL: 026864 FRAME: 0385 OP \$40,00 13163200

CLIENT REF. 2010P50448 US C&B REF. 5497-287

ASSIGNMENT

For good and valuable consideration, we,

Tao Hong, a citizen of China, residing at Auf der Borg 9 59594 Soest, Germany, Markus Thoben, a citizen of Germany, residing at Vor dem Schueltinger Tor 48 59494 Soest, Germany,

hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to Infineon Technologies AG, having its principal place of business at Am Campeon 1-12, 85579 Neubiberg, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

filed on <u>June 17, 2011</u>

US Serial No. 13/163200

entitled: Circuit Arrangement with Shunt Resistor

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements an the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, it successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE:

RECORDED: 09/07/2011

DATE: 7.05.11

DATE: 7.9.11

PATENT REEL: 026864 FRAME: 0386